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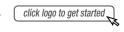
Vishay General Semiconductor

SMD Photovoltaic Solar Cell Protection Rectifier



SMC (DO-214AB)

DESIGN SUPPORT TOOLS





PRIMARY CHARACTERISTICS					
I _{F(AV)}	5.0 A				
V _{RRM}	1000 V				
I _{FSM}	100 A				
I _R	10 µA				
V _F at I _F = 5.0 A	0.90 V				
T _J max.	150 °C				
Package	SMC (DO-214AB)				
Circuit configuration	Single				

FEATURES

- Low profile package
- · Ideal for automated placement
- Glass passivated pellet chip junction
- Low forward voltage drop
- · Low leakage current
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in solar cell panel blocking diode for protection, using DC forward current without reverse bias.

MECHANICAL DATA

Case: SMC (DO-214AB) Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)						
PARAMETER		SYMBOL	S5MS	UNIT		
Device marking code			5MS			
Max. repetitive peak reverse voltage		V _{RRM}	1000	V		
Max DC forward autropt (fig. 1)	T _M = 110 °C	I _F	5.0 (1)	^		
Max. DC forward current (fig. 1)	T _A = 25 °C		1.6 ⁽²⁾	A		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load		I _{FSM}	100	А		
Operating junction and storage temperature range		T _{OP} , T _{STG}	-55 to +150	°C		
Junction temperature in DC forward current without reverse bias, t \leq 1 h $^{(3)}$		TJ	≤ 200	°C		

Notes

⁽¹⁾ Mounted on 30 mm x 30 mm AI PCB

⁽²⁾ Free air, mounted on recommended copper pad area

⁽³⁾ Meets the requirements of IEC 61215 Ed. 2 bypass diode thermal test





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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CO	ONDITIONS	SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 2.5 A	T _A = 25 °C	V _F ⁽¹⁾	0.94	-	- V
	I _F = 5.0 A			0.99	1.15	
	I _F = 2.5 A	T _A = 125 °C		0.82	-	
	I _F = 5.0 A			0.90	1.00	
Reverse current	Rated V _B	T _A = 25 °C	I _R ⁽²⁾	-	10	μA
	naleu v _R	T _A = 125 °C		50	250	
Max. reverse recovery time	I _F = 0.5 A, I _R = I _{rr} = 0.25 A	1.0 A,	t _{rr}	2.5	-	μs
Typical junction capacitance	4.0 V, 1 MHz		CJ	40	-	pF

Notes

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)					
PARAMETER	SYMBOL	S5MS	UNIT		
Typical thermal registerion	R _{0JA} ⁽¹⁾	92	°C/W		
Typical thermal resistance	R _{0JM} ⁽²⁾	8	0/10		

Notes

⁽¹⁾ Free air, mounted on recommended copper pad area. Thermal resistance $R_{\theta JA}$ - junction-to-ambient

 $^{(2)}$ Mounted on 30 mm x 30 mm AI PCB. Thermal resistance $R_{\theta JM}$ - junction-to-mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
S5MS-E3/57T	0.211	57T	850	7" diameter plastic tape and reel	
S5MS-E3/9AT	0.211	9AT	3500	13" diameter plastic tape and reel	

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

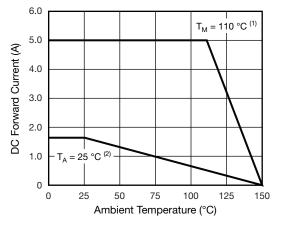


Fig. 1 - Forward Current Derating Curve

Notes

- $^{(1)}$ Mounted on 30 mm x 30 mm Al PCB T_M measured at the terminal (R_{\theta JM} = 8 $^\circ C/W)$
- $^{(2)}$ Free air, mounted on recommended copper pad area (R_{θ JA} = 92 °C/W)

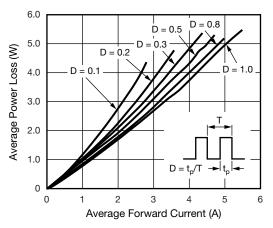
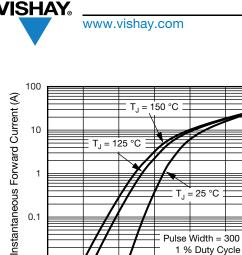


Fig. 2 - Forward Power Loss Characteristics

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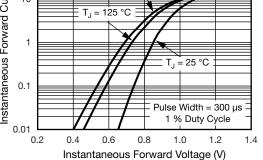


Fig. 3 - Typical Instantaneous Forward Characteristics

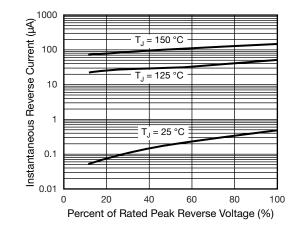
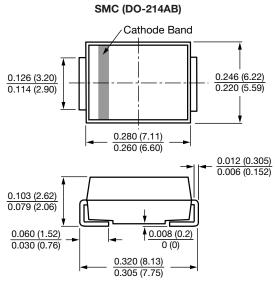


Fig. 4 - Typical Reverse Characteristics

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



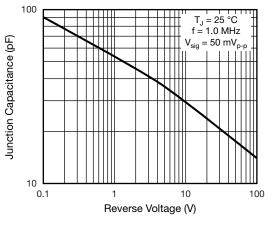
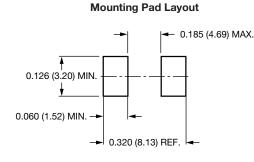


Fig. 5 - Typical Junction Capacitance



Revision: 10-Aug-2018

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